EVB-SEC1110/EVB-SEC1210/ EVB-SEC1212-DEV Evaluation Board User's Guide

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Date

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Preface

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For the most up-to-date information on development tools, see the MPLAB® IDE online help. Select the Help menu, and then Topics to open a list of available online help files.

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CONVENTIONS USED IN THIS GUIDE

This manual uses the following documentation conventions:

DOCUMENTATION CONVENTIONS

Description	Represents	Examples
Arial font:		
Italic characters	Referenced books	*MPLAB® IDE User's Guide*
	Emphasized text	...is the *only* compiler...
Initial caps	A window	the Output window
	A dialog	the Settings dialog
	A menu selection	select Enable Programmer
Quotes	A field name in a window or dialog	"Save project before build"
Underlined, italic text with right angle bracket	A menu path	*File>Save*
Bold characters	A dialog button	Click **OK**
	A tab	Click the **Power** tab
N'Rnnnn	A number in verilog format, where N is the total number of digits, R is the radix and n is a digit.	4'b0010, 2'hF1
Text in angle brackets < >	A key on the keyboard	Press <Enter>, <F1>
Courier New font:		
Plain Courier New	Sample source code	`#define START`
	Filenames	`autoexec.bat`
	File paths	`c:\mcc18\h`
	Keywords	`_asm, _endasm, static`
	Command-line options	`-Opa+, -Opa-`
	Bit values	`0, 1`
	Constants	`0xFF, 'A'`
Italic Courier New	A variable argument	*`file`*`.o`, where *`file`* can be any valid filename
Square brackets [ ]	Optional arguments	`mcc18 [options]` *`file`* `[options]`
Curly brackets and pipe character: { | }	Choice of mutually exclusive arguments; an OR selection	`errorlevel {0|1}`
Ellipses...	Replaces repeated text	`var_name [, var_name...]`
	Represents code supplied by user	`void main (void) { ... }`

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- **Emulators** – The latest information on Microchip in-circuit emulators.This includes the MPLAB REAL ICE and MPLAB ICE 2000 in-circuit emulators.
- **In-Circuit Debuggers** – The latest information on the Microchip in-circuit debuggers. This includes MPLAB ICD 3 in-circuit debuggers and PICkit 3 debug express.
- **MPLAB IDE** – The latest information on Microchip MPLAB IDE, the Windows Integrated Development Environment for development systems tools. This list is focused on the MPLAB IDE, MPLAB IDE Project Manager, MPLAB Editor and MPLAB SIM simulator, as well as general editing and debugging features.
- **Programmers** – The latest information on Microchip programmers. These include production programmers such as MPLAB REAL ICE in-circuit emulator, MPLAB ICD 3 in-circuit debugger and MPLAB PM3 device programmers. Also included are nonproduction development programmers such as PICSTART Plus and PIC-kit 2 and 3.

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- Technical Support

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DOCUMENT REVISION HISTORY

Revision A (September 2013)

- Initial Release of this Document.

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Chapter 1. Introduction

The SEC1110/SEC1210/SEC1212-DEV is a family low power, OEM configurable, single-chip smartcard reader solutions. Three evaluation boards (EVBs) are available for device development:

- EVB-SEC2112-DEV
- EVB-SEC1210
- EVB-SEC1110

These EVBs demonstrate standalone solutions with all of the interfaces and features listed the following sub-sections. For details on each individual EVB, refer to Chapter 2.

1.1 SEC1110 FEATURES

1.1.1 Smartcard

- Single Smartcard slot
- Fully compliant with the ISO/IEC 7816, EMV and PC/SC standards
- Versatile ETU rate generation, supporting current and proposed rates (to 861 Kbps and beyond)
- Full support of both T=0 and T=1 protocols
- Full-packet FIFO (259 bytes) for transmit and receive
- Half-Duplex operation, with no software intervention required between transmit and receive phases of an exchange
- Very loose real-time response required of software
- (worst case scenario of approximately 180 ms)
- Dynamically programmable FIFO threshold, with byte granularity
- Time-out FIFO flush interrupt, independent of threshold
- Programmable Smart Card clock frequency
- UART-like register file structure
- Supports Class A, Class B, Class C, or Class AB Smart Cards (all 1.8 V, 3 V and 5 V cards)
- Automatic Character Repetition for T=0 protocol Parity Error recovery
- Automatic card deactivation on card removal and on other system events, including persistent Parity Errors

1.1.2 USB

- Supports Full-Speed data transfer
- Endpoints can be configured for control, bulk & interrupt transfer types
- Max packet size configurable for each endpoint
- (8 / 16/ 32/ 64 bytes are allowed)
- Ping pong buffers supported for non-control endpoints

- Supports Suspend, Resume, and Remote Wakeup per the USB specification requirements
- Endpoint buffer may be located anywhere in the 1.5K SRAM, as per the alignment requirements based on the max packet size

1.2 SEC1210 FEATURES

Along with the features mentioned in Section 1.1, the SEC1210 includes two Smartcard slots and the following additional features:

1.2.1 SPI1

- Supports full-duplex mode
- Supports master or slave mode
- Supports seven SPI1 Master baud rates
- Slave Clock rate up to spi1_clk/8
- Serial clock with programmable polarity and phase
- Master Mode fault error flag with MCU interrupt capability
- Write collision flag protection
- Byte Transfer/Receive APIs
- Bulk Transfer/ Receive APIs
- Simultaneous Transfer/ Receive APIs

1.2.2 UART

- Software compatible with Standard 16C450 and 16C550A
- Separate 16 byte FIFO for transmission and reception
  - Prevents buffer overrun
  - Helps software to be less time critical in handling transmission / reception
- Programmable baud rate generator - Up to 3 Mbps baud rate can be achieved
- Supports flow control using RTS / CTS signals
- Pin Polarity control
- Programmable communication parameters:
  - Word length - 5, 6, 7, 8 bits
  - Stop bits - 1, 1.5, 2 bits
  - Parity - None, Odd, Even, Mark, Space
- Low power sleep mode available

Note: A voltage level shifter board / cable is required to connect the UART port to the PC. An FTDI cable is used for this.

1.3 SEC1212-DEV FEATURES

Along with the features mentioned in section 1.1 and1.2 the following modules are also available in the SEC1212-DEV:

- Boot from SPI2 Interface
- The SVB is equipped with a 1Kbyte Atmel SPI flash (AT26DF081A-SSU). SPI flash from Atmel and Windbond are supported.
- On-board RS232 Transceiver for debugging as well as RS232 host interface
- On-board Reset button
- On-board EDP header for f/w debugging.
- On-board JTAG header for entering ASIC test mode and debugging

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1.4 DIRECTORY STRUCTURE

The EVB-SEC2112-DEV release package provides the following file/folder structure:

EVB Schematics & BOM

Contains EVB schematics and BOM

SW Tools/WinUSB Driver

This is the device driver required for BootROM USB Device

SW Tools/OTPProgrammer

Contains the OTP programming utility and user manual

SW Tools/Linux Libraries

Contains the required Linux libraries

SW Tools/SPIFlashUtitly

Contains utility to program the SEC1212-DEV SPI2 flash and the relevant user manual.

Firmware

This folder contains the firmware binary files for programming into the OTP / SPI Flash. Filenames with "SPI2" are intended to be programmed onto the SPI flash using SPI-FlashWriter application. Filenames with "OTP" are intended to be programmed onto the OTP using OTPProgrammer application. Similarly, "SINGLESLOT" or "DUALSLOT" in the file name indicates a single slot or dual slot reader, respectively.

Chapter 2. EVBPCBA Documentation

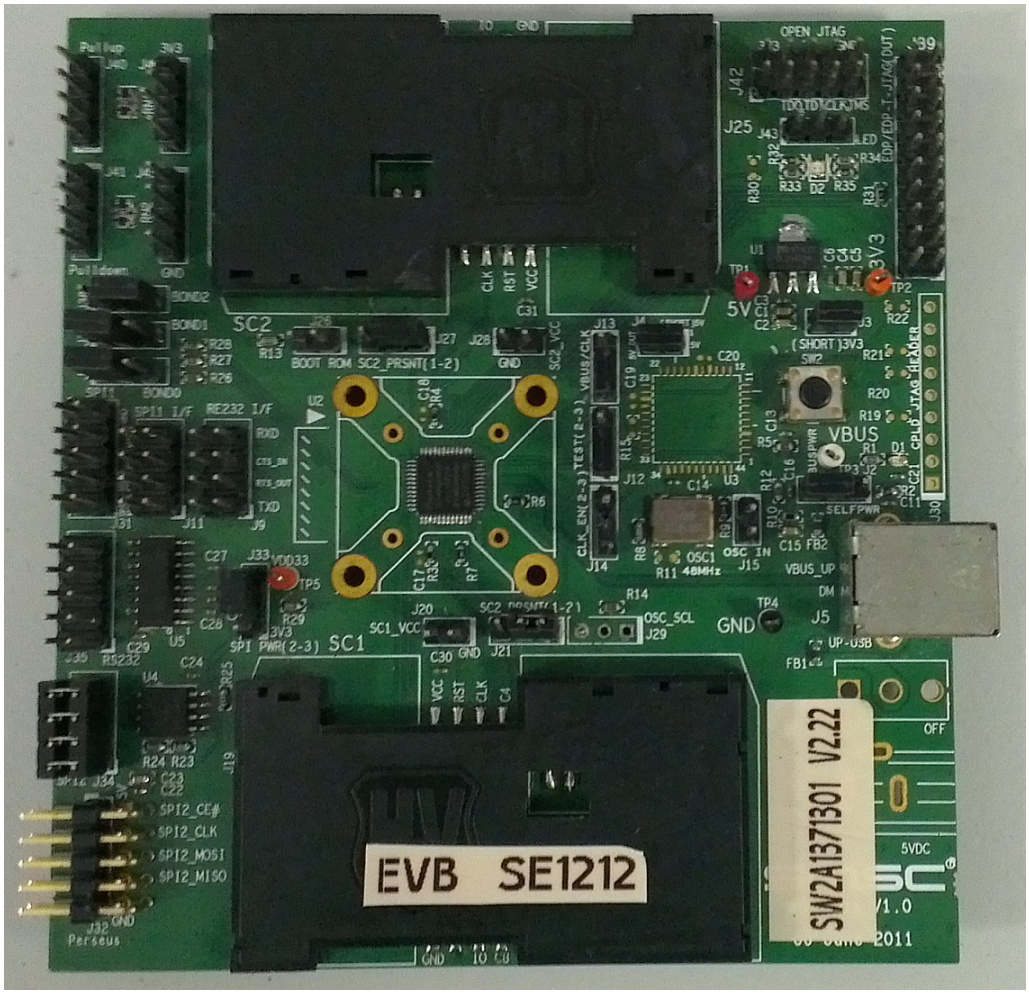
This chapter details the evaluation boards available for the SEC family of ASIC's and their hardware settings. A standard USB A-to-B cable is required to connect the EVB to the USB Host.

2.5 EVB-SEC2112-DEV

The EVB-SEC2112-DEV includes a 48-pin QFN SEC1212-DEV with the following interfaces and features:

- USB host interface
- Two smartcard slots
- SPI1
- SPI2 Code execution (Either from external or on board flash)
- UART
- Input bond options allow a single chip to function as either an SEC1110 or SEC1210.

FIGURE 2-1: EVB-SEC2112-DEV PROTOTYPE COMPONENT SIDE TOP LAYER

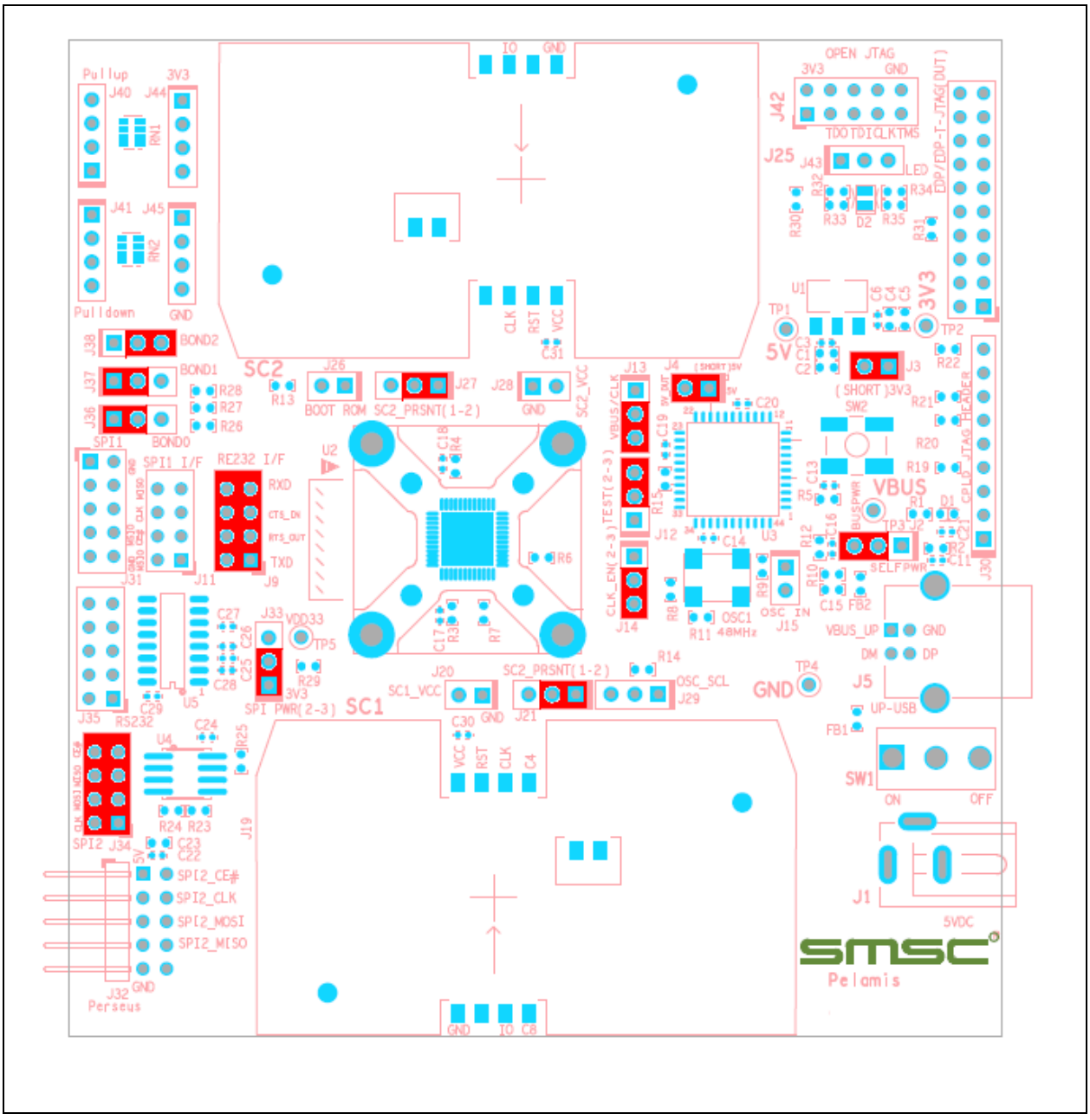


2.5.1 Board Layout

Please follow this legend to understand the following figure.

1. In each header, Pin 1 is represented by a thick band near the edge.
2. Pins filled in dark red indicate they are to be shorted by a jumper.

FIGURE 2-2: DEFAULT BOARD SETUP TO RUN FROM OTP USING INTERNAL OSCILLATOR IN SEC1212-DEV (QFN48) MODE



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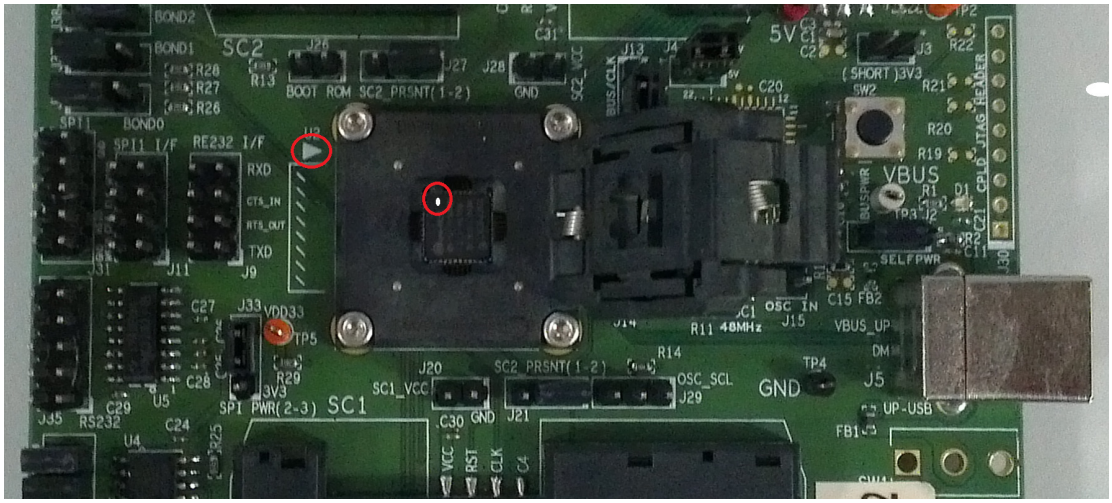
2.5.2 Inserting a Chip into the Socket

This section is applicable only if the ASIC is not directly soldered on the PCB and the EVB is equipped with a socket. The following guidelines must be followed when replacing the ASIC in the socket.

Place the ASIC in the socket in such a way that the Pin1 marking (dot) on the ASIC and the socket Pin1 marking on the PCB (triangle) align, as shown in Figure 2-3.

Note: The socket is manufactured by R&D Interconnect (P/N: 106458-0020).

FIGURE 2-3: EVB-SEC2112-DEV PIN 1 SOCKET ALIGNMENT



2.5.3 Connector Description

Note: The board's default settings are indicated in the *Settings* column.

Connector	Description	Settings	
J2	Self/Bus Power Header	1 --- 2 2 --- 3	Supplied Externally Supplied by Upstream VBUS (default)
J3	Power IN	1-2	Short (default)
J4	5V_DUT	1-2	Short (default)
J9	MUX'd RS232-I/F	1-2 3-4 5-6 7-8	Short (and open J11) to select RS232 interface

Connector	Description	Settings	
J11	MUX'd SPI1-I/F	1-2 3-4 5-6 7-8	Short (and open J9) to select SPI1 interface
J12	TEST	1-2 2-3	Chip will enter TEST mode Chip will enter functional mode (default)
J13	JTAG Select Header	1 --- 2 2 --- 3	JTAG_CLK (JTAG CLK is routed from J39 when this setting is selected) VBUS_DET(default)
J14	PCLK_ENABLE	1-2 2-3	Chip starts with external oscillator Chip starts with internal oscillator (default)
J15	OSC_IN	1-2	External oscillator is fed to PCLK_IN_48MHZ. To be shorted if the chip is to work from external oscillator
J20	SC1_Load	1-2	Open (default)
J21	SC1_PRSNT	1-2 2-3	SC1 Card detect pin routed from smartcard connector (default) SC1 card detect pin is permanently grounded
J26	BootROM select	1-2	Open (default)
J27	SC2_PRSNT	1-2 2-3	SC2 Card detect pin routed from smartcard connector (default) SC2 card detect pin is permanently grounded
J28	SC2_Load	1-2	Open (default)
J29	OSC_SEL	Unused	Open (default)
J31	SPI1_Interface	1-10	Open (default). Header for connecting Cheetah / Aardvark SPI host adapters
J34	SPI2_Internal Flash	1-8	Short to program SPI2 flash and execute code from
J35	RS232 10 pin header	1-10	Header to which Microchip's 10 pin serial cable to be connected

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Connector	Description	Settings	
J36	Bond 0 Configuration Header	1 --- 2 2 --- 3	Pulled high to VDD33 (default) Pulled down to GND
J37	Bond 1 Configuration Header	1 --- 2 2 --- 3	Pulled high to VDD33 (default) Pulled down to GND
J38	Bond 2 Configuration Header	1 --- 2 2 --- 3	Pulled high to VDD33 Pulled down to GND (default) for OTP / ROM execution
J19	Smart Card 1 (SC1 I/F – Credit Card)	10 9 8 4 7 3 6 2 5 1	CDSW2 (GND) SC1_PRSNT# SC1_C8 SC1_C4 SC1_IO SC1_CLK NC SC1_RST# GND SC1_VCC
J25	Smart Card 2 (SC2 I/F – Credit Card)	10 9 8 4 7 3 6 2 5 1	CDSW2 (GND) SC2_PRSNT# NC NC SC2_IO SC2_CLK NC SC2_RST# GND SC2_VCC
J39	DUT EDP/EDP-T JTAG Header	2,6,10,16 1,3,4,5,7,9,11,13,15,17,19,20 8 12 14 18	nc pins GND Test Points TCK (JTAG_CLK) TDO (PJTAG_TDO) TDI (PJTAG_TDI) TMS (PJTAG_TMS)
J40	General purpose pull up to 3.3V thru 1K ohm resistor	1-4	Open (default)

Connector	Description	Settings	
J41	General purpose pull down to GND thru 1K ohm resistor	1-4	Open (default)
J42	Open JTAG Header	Unused	Open (default)
J43	LED Polarity control	2-3	Short (default)
J44	3V3	1-4	Open (default). Connected to 3.3V
J45	GND	1-4	Open (default). Connected to GND

2.5.4 Switch Description

Ref. Des	Description	Settings
SW2	Reset Switch	Press : In Reset Release : Out of Reset

2.5.5 Test Points Description

Test Point	Description	Connection
TP1	5V	5V input to MIC37100 3.3V regulator (U1) & SEC1210 (U2)
TP2	3.3V	3.3V output of MIC37100 3.3V regulator (U1)
TP4	GND	GND
TP5	VDD33	VDD33 power output of internal regulator

2.5.6 Bond Options

Depending on the Bond option set on jumper J36, J37 and J38, the SEC1212-DEV prototype can work in SEC1210 (QFN24) and SEC1110 (QFN16) pin modes also.

PART No.	BOND0(J36)	BOND1(J37)	BONd2(J38)	Remarks
SEC1110	0	0	x	
SEC1210	0	1	x	
SEC1212-DEV	1	1	0	OTP/Internal ROM boot
SEC1212-DEV	1	1	1	External SPI2 Flash boot

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2.5.7 Selecting the Code Fetch Source

SEC1212-DEV can execute code from Internal /OTP ROM as well as from external serial SPI flash (one at a time).

The following sub-sections detail the pre-requisites to select the required code fetch source.

2.5.7.1 CODE EXECUTION FROM INTERNAL BOOT ROM

1. OTP_ROM_EN & FORCE_OTP_ROM bits are not programmed through OTP Programmer application
2. Pins 2-3 of J38 are to be shorted

2.5.7.2 CODE EXECUTION FROM INTERNAL OTP ROM

1. OTP should have been programmed through OTP Programmer application
2. OTP_ROM_EN bit is programmed through OTP Programmer application
3. Pins 2-3 of J38 are to be shorted

2.5.7.3 CODE EXECUTION FROM SPI FLASH

1. SPI Flash should have been programmed through SPI Flashwriter application
2. FORCE_OTP_ROM bit is not programmed through OTP Programmer application
3. Pins 1-2 of J38 are to be shorted

2.6 EVB-SEC1210

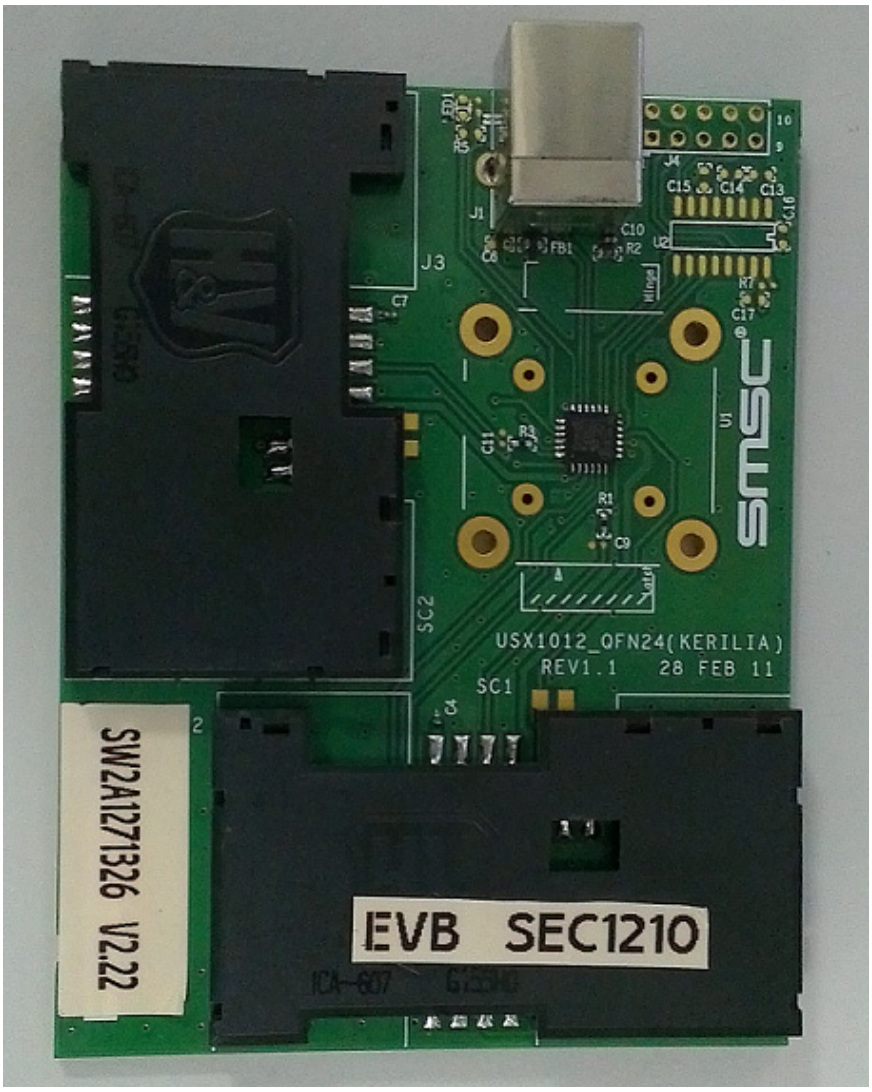
The EVB-SEC1210 utilizes the 24-pin QFN SEC1210 and includes the following interfaces and features.

- USB
- Two smartcard slots
- SPI1 or UART Interface

Note 1: A standard USB A-to-B cable is required to connect to the USB Host.

2: Code execution is possible only from internal SRAM or OTP.

FIGURE 2-4: EVB-SEC1210 COMPONENT SIDE TOP LAYER



2.6.1 Placing a Chip in the Socket

This section is applicable only if the ASIC is not directly soldered on the PCB and the EVB is equipped with a socket. The following guidelines must be followed when replacing the ASIC in the socket.

Place the ASIC in the socket in such a way that the Pin1 marking (dot) on the ASIC and the socket Pin1 marking on the PCB (triangle) align, as shown in Figure 2-5.

Note: The socket is manufactured by R&D Interconnect (P/N: 106458-0133).

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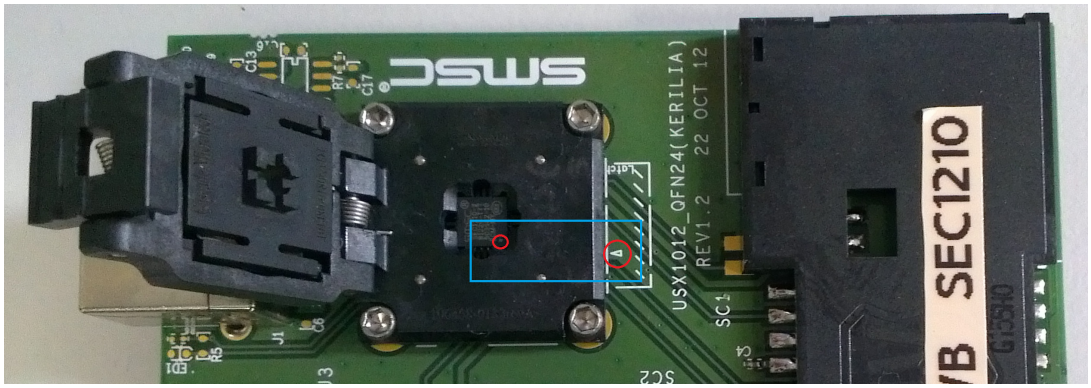
FIGURE 2-5: EVB-SEC1210 PIN 1 SOCKET ALIGNMENT



2.6.2 Connector Description

Ref. Des.	Description	Settings	
J1	USB-B Upstream Connector	5,6 1 2 3 4	Shield connections to earth GND VBUS_UP USBUP_DM USBUP_DP GND
J2	Smart Card 1 (SC1 I/F – Credit Card)	10 9 8 4 7 3 6 2 5 1	CDSW2 (GND) SC1_PRSNT# SC1_C8 SC1_C4 SC1_IO SC1_CLK NC SC1_RST# GND SC1_VCC
J3	Smart Card 2 (SC2 I/F – Credit Card)	10 9 8 4 7 3 6 2 5 1	CDSW2 (GND) SC2_PRSNT# NC NC SC2_IO SC2_CLK NC SC2_RST# GND SC2_VCC
J4	RS-232 D-sub9 connector	1-10	Header to which SMSC's 10 pin RS232 cable needs to be connected

2.7 EVB-SEC1110

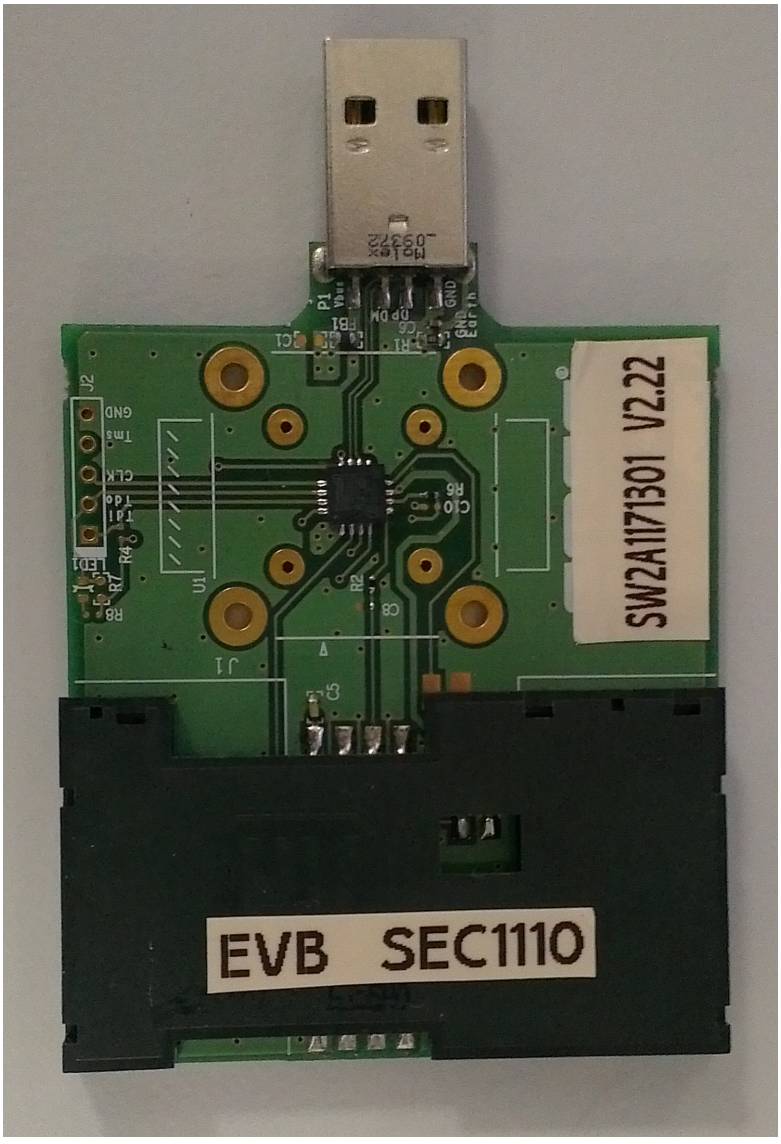
The EVB-SEC1110 utilizes the 16-pin QFN SEC1110 and includes the following interfaces and features.

- USB
- One smartcard slot

Note 1: A standard USB A-to-B cable is required to connect to the USB Host.

2: Code execution is possible only from internal SRAM or OTP.

FIGURE 2-6: EVB-SEC1110 COMPONENT SIDE TOP LAYER



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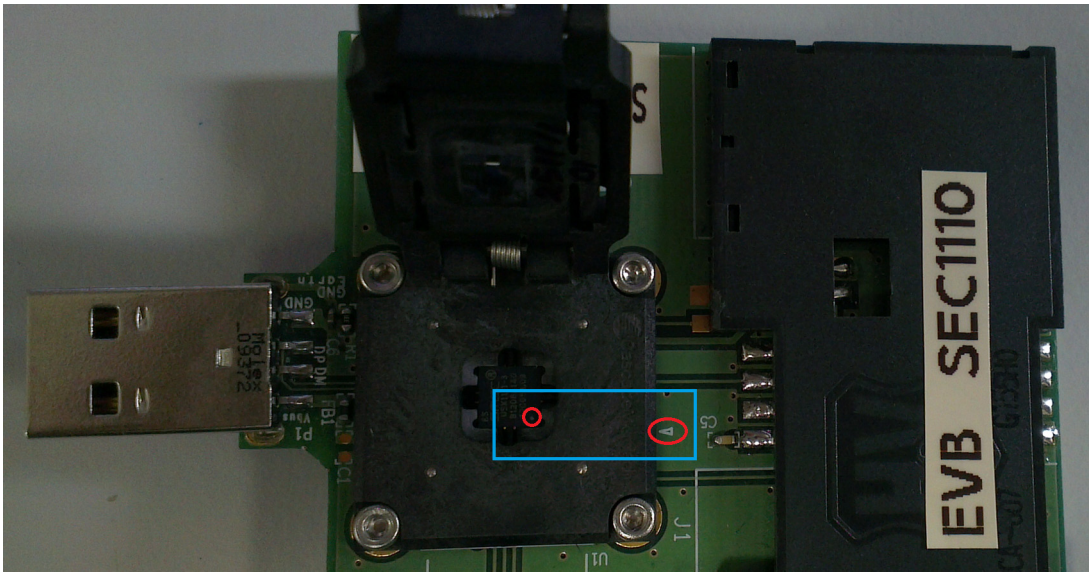
2.7.1 Placing a Chip in the Socket

This section is applicable only if the ASIC is not directly soldered on the PCB and the EVB is equipped with a socket. The following guidelines must be followed when replacing the ASIC in the socket.

Place the ASIC in the socket in such a way that the Pin1 marking (dot) on the ASIC and the socket Pin1 marking on the PCB (triangle) align, as shown in Figure 2-7.

Note:	The socket is manufactured by R&D Interconnect (P/N: 106458-0134).

FIGURE 2-7: EVB-SEC1110 PIN 1 SOCKET ALIGNMENT



2.7.2 Connector Description

Ref. Des.	Description	Settings	
P1	USB-A Upstream Connector	5,6 1 2 3 4	Shield connections to earth GND VBUS_UP USBUP_DM USBUP_DP GND
J1	Smart Card 1 (SC1 I/F – Credit Card)	10 9 8 4 7 3 6 2 5 1	CDSW2 (GND) SC1_PRSNT# SC1_C8 SC1_C4 SC1_IO SC1_CLK NC SC1_RST# GND SC1_VCC

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Chapter 3. CCID Firmware

3.8 FEATURES

- Supports smartcards of all voltages (1.8V, 3V and 5V)
- Supports T=0 and T=1 protocols
- Supports the fastest possible smartcards. (As per ISO Spec, ATR with TA1=17 is the maximum speed possible for a smartcard. This is equivalent to 826Kbps.)
- Has a maximum CCID command length of 271 bytes
- Supports suspending the device in order to save power
- Remote wake-up is possible through smartcard insertion. When host is in suspended state, on inserting a smartcard, the device will wake up the host.
- Support in-box drivers of all Windows and Linux versions

3.9 SINGLE SLOT CCID FIRMWARE

- USB CCID class compliant single slot firmware
- This firmware supports EVB-SEC1110, EVB-SEC1210 & EVB-SEC2112-DEV boards
- Card can be removed / re-inserted. Interrupt notification will be sent to host according to card changes in slot.

3.10 DUAL SLOT CCID FIRMWARE

- USB CCID class compliant dual slot firmware (enumerates as a composite USB device)
- This firmware supports EVB-SEC1210 & EVB-SEC2112-DEV boards
- In slot1, card removed / re-insertion is supported
- In slot2, card removal / re-insertion is not supported as no status change interrupt endpoint is supported for this interface

3.11 SMARTCARD READER DRIVER INSTALLATION UNDER WINDOWS

Most Windows OS installations include USBCCID drivers integrated by default. In these cases, as soon as the EVB is connected to the system, the usbccid.sys driver is loaded and the EVB-SEC1110/EVB-SEC1210/EVB-SEC1212-DEV smartcard reader will be listed in the Device Manager as shown below.

FIGURE 3-8: SEC1110 DEVICE ENUMERATION UNDER WINDOWS 7

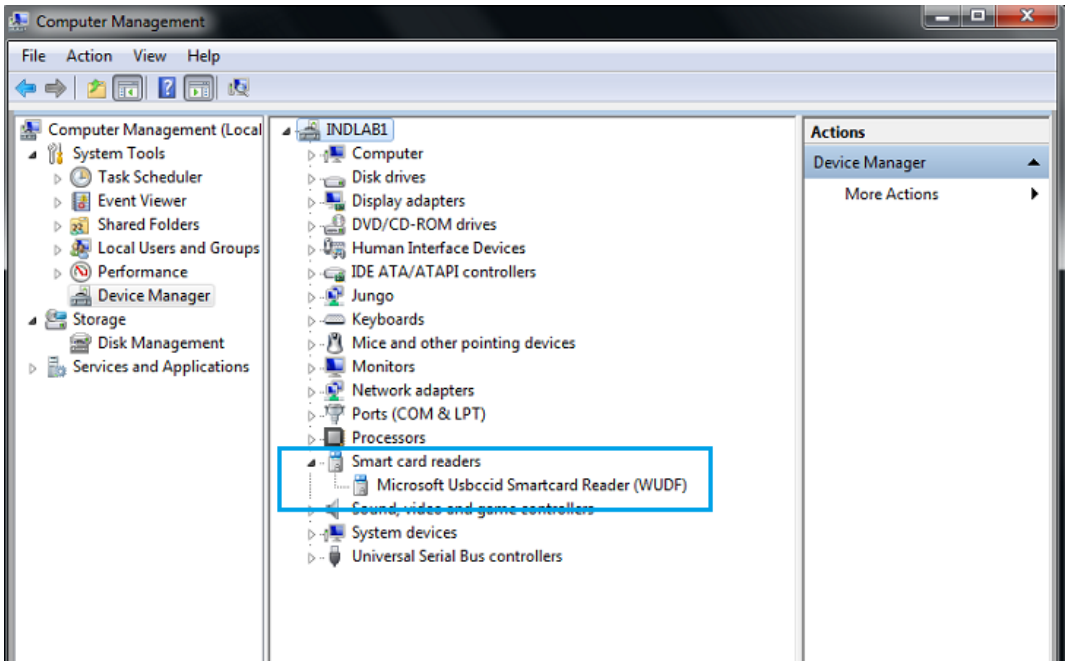
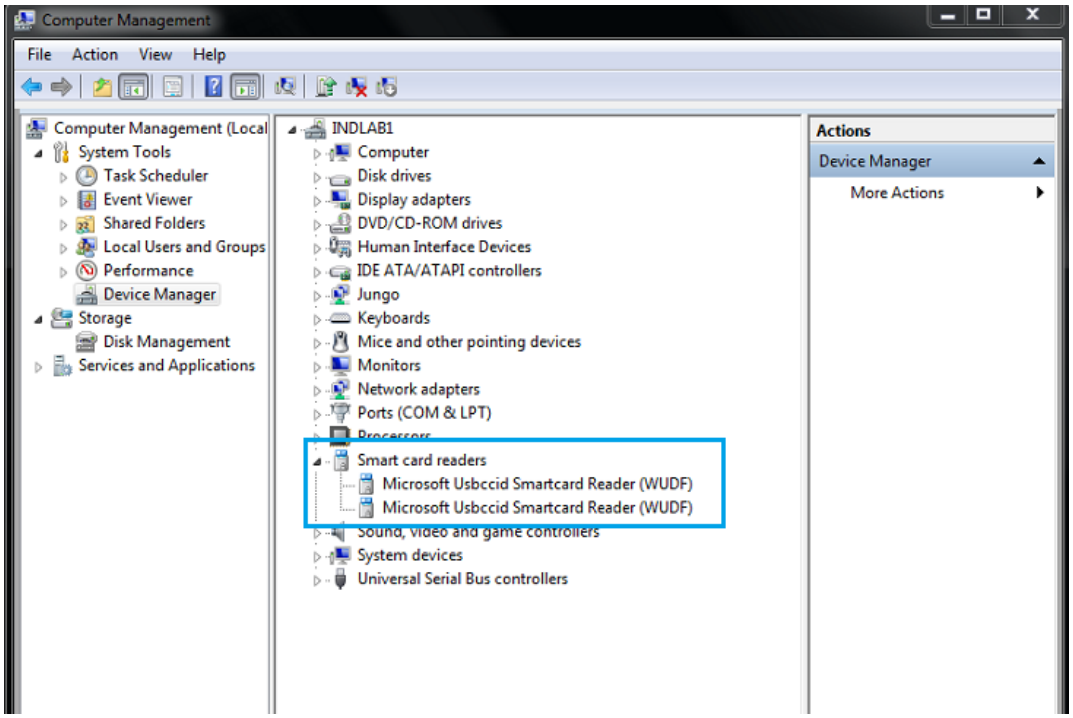


FIGURE 3-9: SEC1210/SEC1212-DEV DEVICE ENUMERATION UNDER WINDOWS 7



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If the driver is has not been pre-installed on the PC, follow the steps below to install the driver via the Windows Update site (Shown for SEC1110 under Windows XP OS).

- Connect the reader to a free USB port on the PC.
- Once the smartcard reader is connected, Window reports that new hardware has been detected and will offer to connect to Windows Update to search for a suitable driver.
- Choose **Recommended Option** and click **Next** to continue.

FIGURE 3-10: FOUND NEW HARDWIRE WIZARD

- Choose **"Yes, Connect and search for software on the Internet"** and click **Next.**

FIGURE 3-11: FOUND NEW HARDWARE WIZARD - OPTIONS

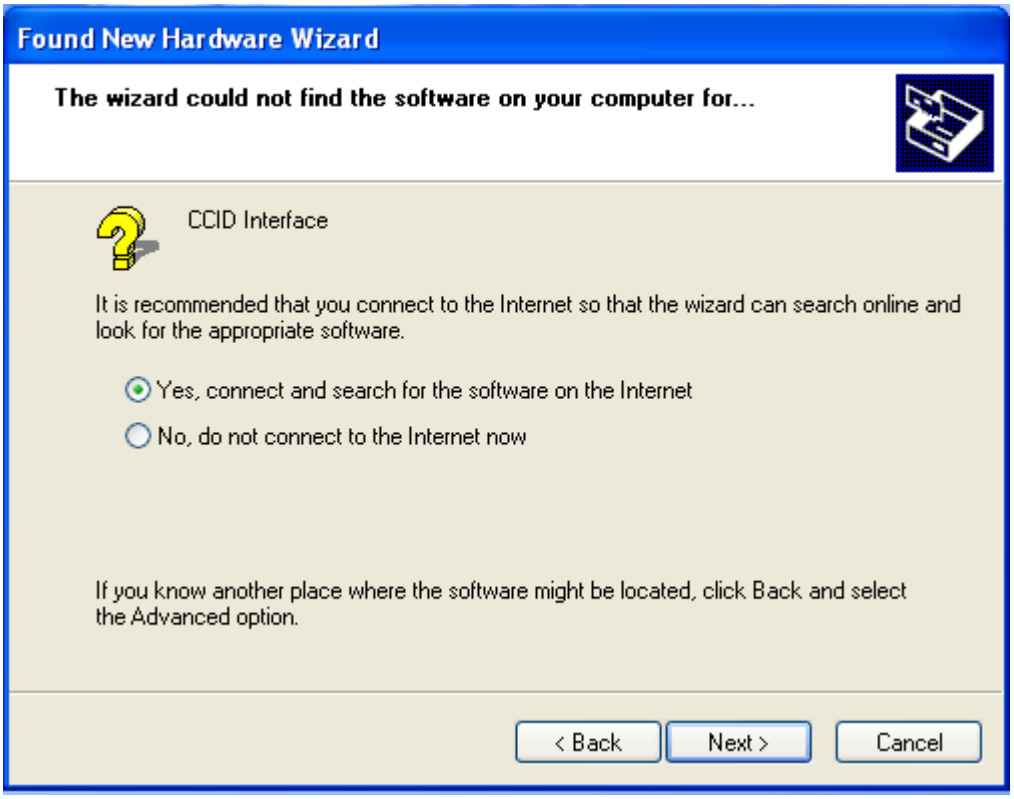

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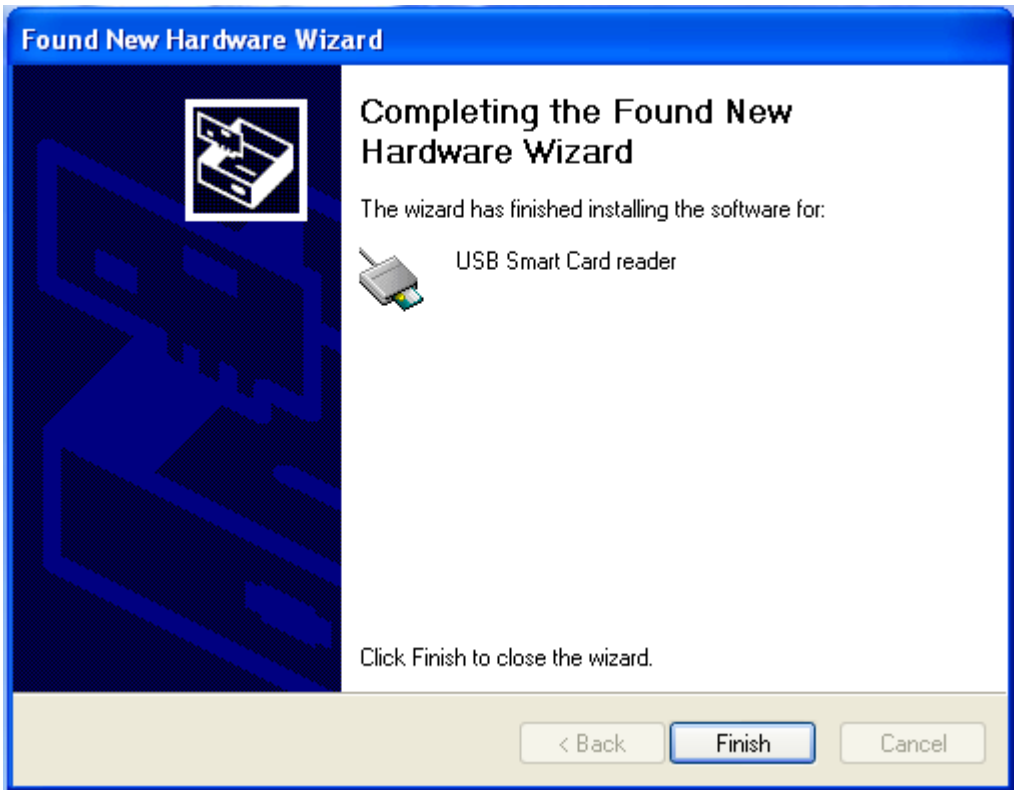
FIGURE 3-12: FOUND NEW HARDWARE WIZARD - SEARCH

FIGURE 3-13: FOUND NEW HARDWARE WIZARD - COMPLETED



- Click **Finish** when the last window shows that the installation has finished.
- After successful driver installation, the device will be included in the Device Manager, as shown in Figure 3-14.

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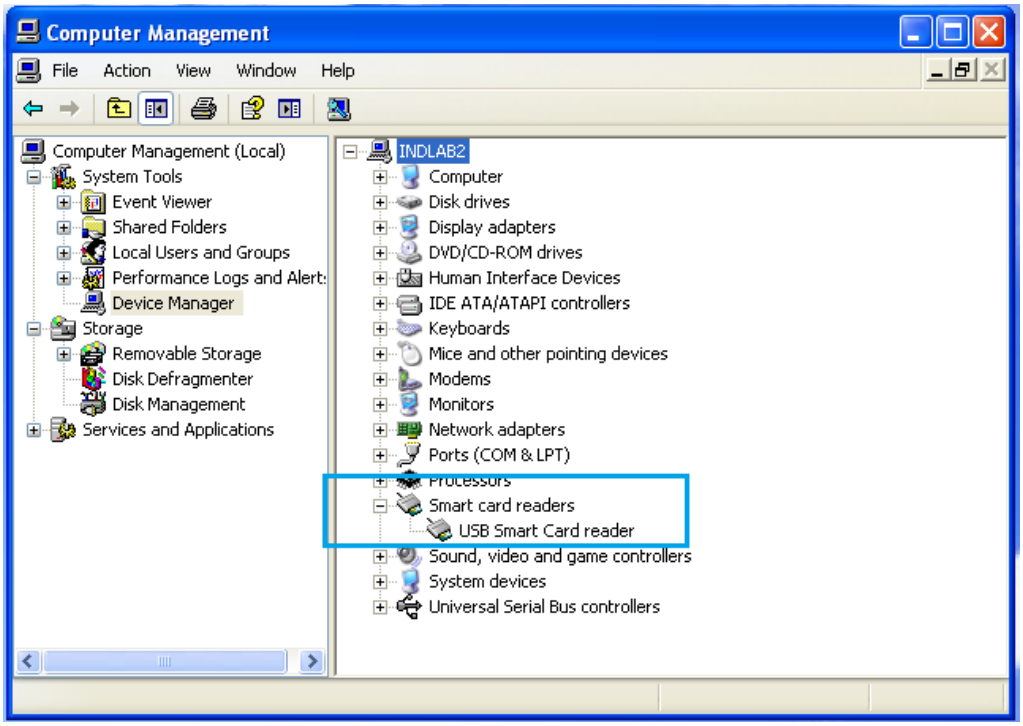
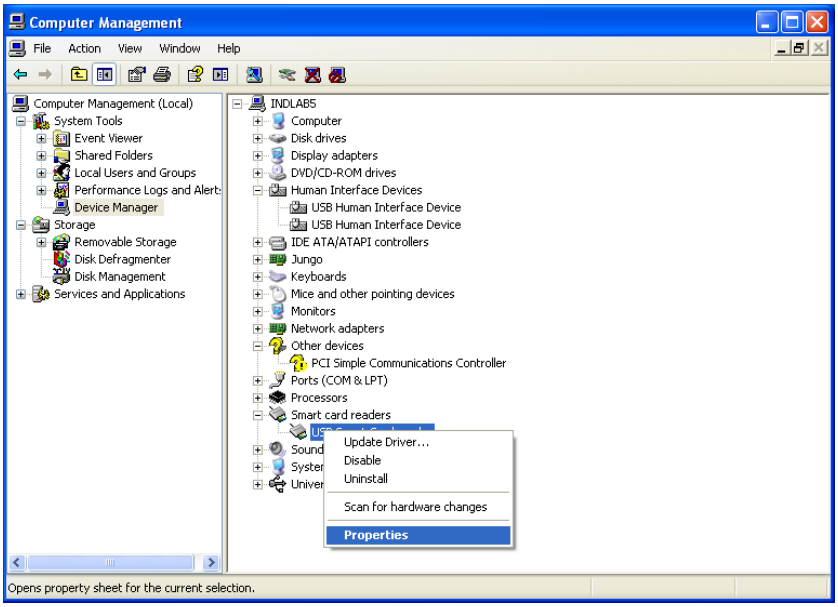
FIGURE 3-14: DEVICE MANAGER - NEW DEVICE



Chapter 4. Checking Device Firmware Revision

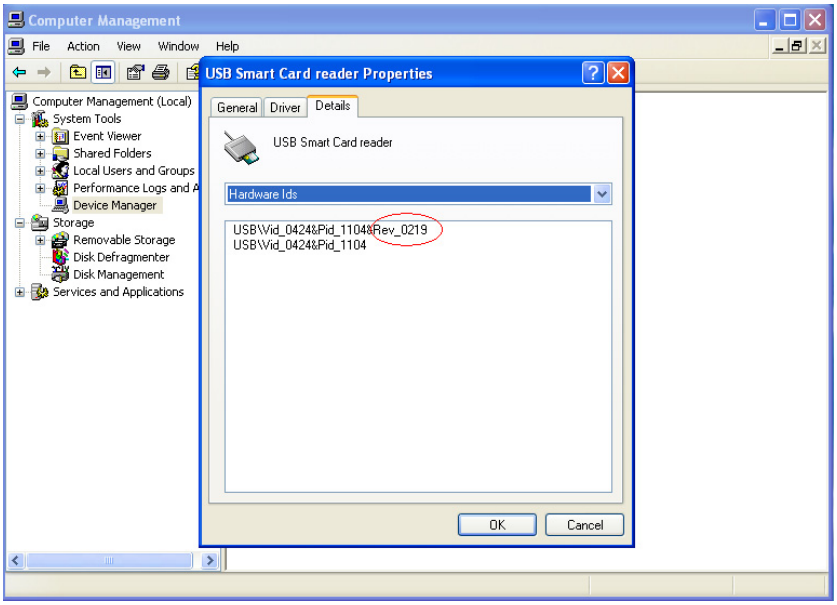
To check the device's firmware revision, go to Device Manager and select the smart card reader. Right click and select **Properties**.

FIGURE 4-15: DEVICE MANAGER - PROPERTIES



In the **Details** tab select **Hardware Ids**, where the revision number is listed.

FIGURE 4-16: DEVICE MANAGER - FIRMWARE REVISION



Note 1: F/W version in the above case is 2.19

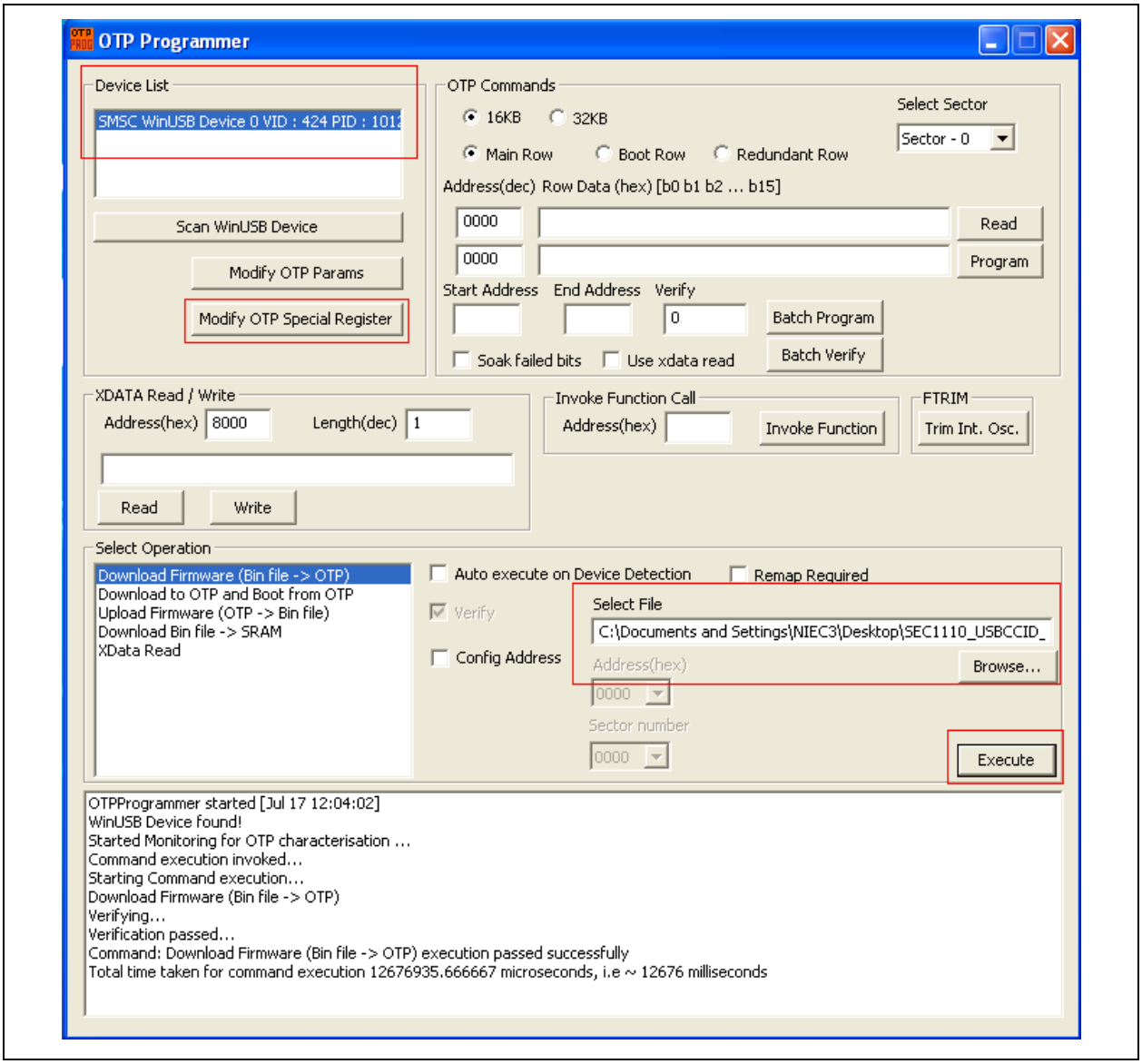
2: If the reader is enumerated as SMSC WINUSB, then the device is not programmed.

Chapter 5. OTP Programming Procedures

Note: This procedure is applicable only to EVB-SEC2112-DEV, as the EVB-SEC1110 and EVB-SEC1210 are pre-programmed with appropriate firmware. Only the EVB-SEC2112-DEV includes firmware loaded to SPI2 Flash - and user has an option to program the OTP only once. Once the OTP is programmed and the "OTP_ROM_EN" option is set as detailed in step 6 of the procedure below, the SPI flash cannot be updated again and the boot from OTP or SPI2 can be switched using Jumper J38.

1. The device should enumerate as "SMSC WINUSB". Otherwise the device can't be programmed.
2. Open the OTP Programmer and confirm the device enumerated
3. Select the .bin file using **Browse**… button
4. Click **Execute**

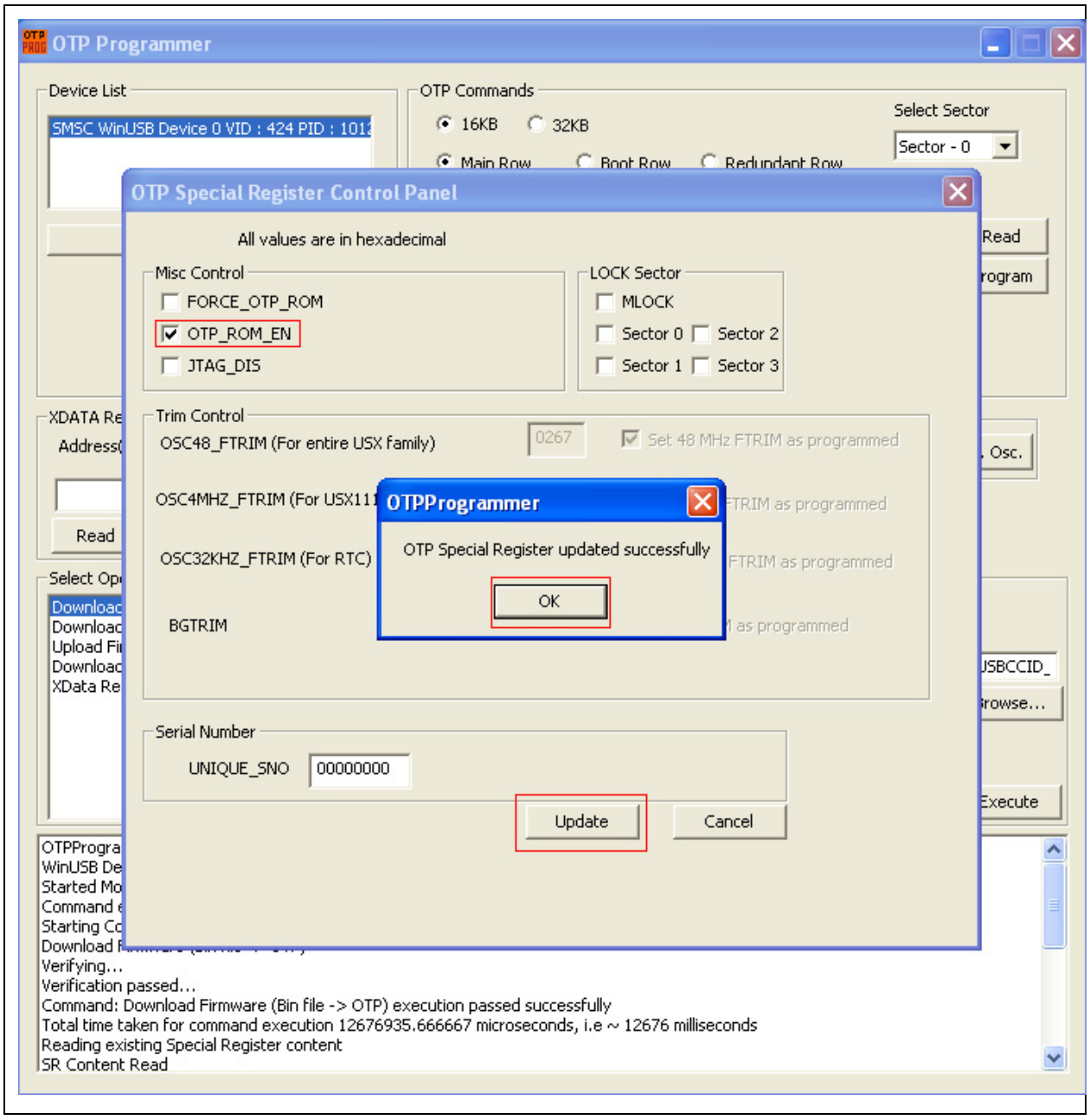
FIGURE 5-17: OTP PROGRAMMER - DEVICE LIST



5. After successful completion, the message shown in Figure 5-17 will be shown in the status box.
6. Select **Modify OTP Special Register** and click the OTP_ROM_EN check box, as shown in Figure 5-18.
7. Select Update and press OK.

Note: Steps 4, 5 and 6 must be performed without resetting the device after OTP programming. Otherwise, the device will enumerate as SMSC WINUSB.

FIGURE 5-18: OTP PROGRAMMER - SPECIAL REGISTER CONTROL PANEL



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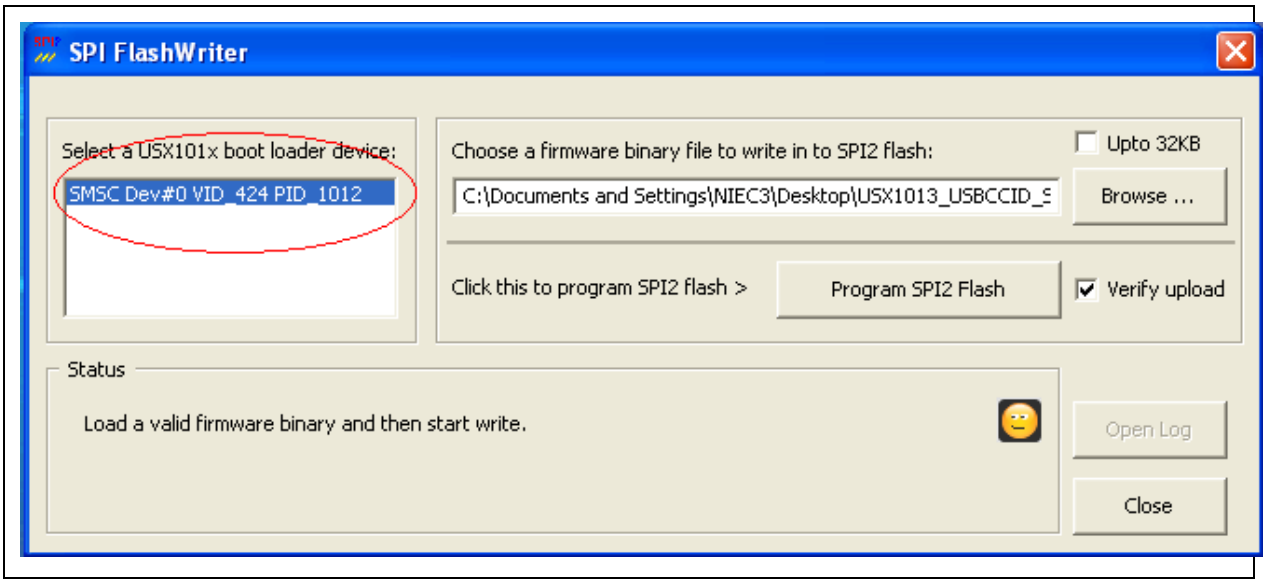
Chapter 6. SPI Programming Procedures

Note: SPI Programming can only be performed on the EVB-SEC2112-DEV.

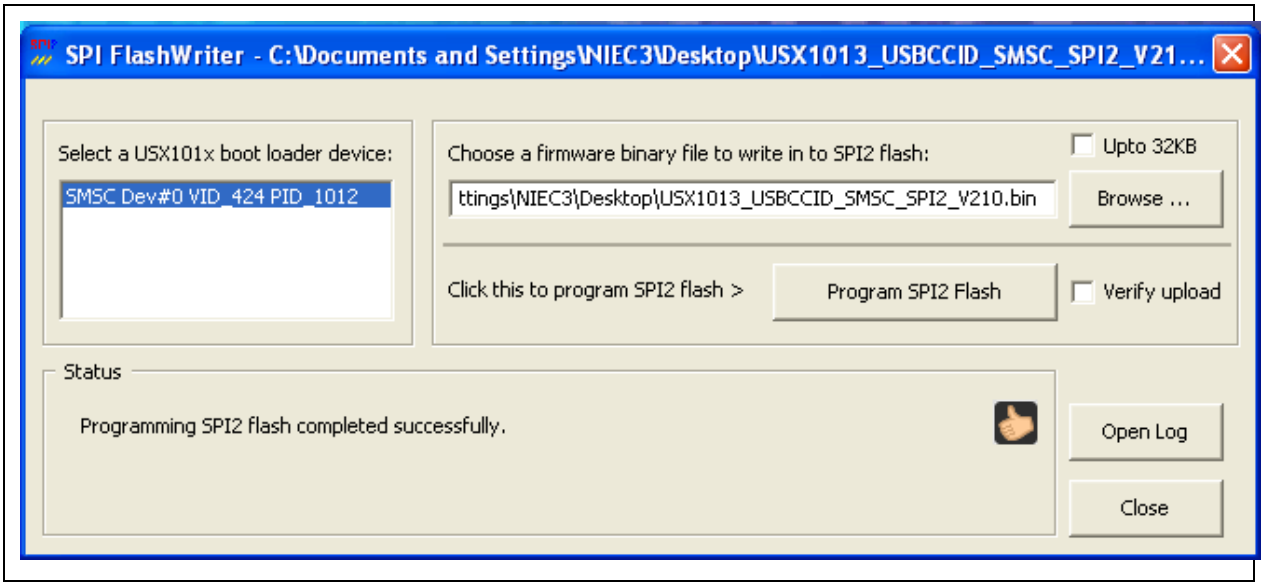
1. In order for the device to enumerate as "SMSC WINUSB", the Bond2 jumper (J38) must be set to 1-2 during power-up.
2. Open SPI Flashwriter and confirm the device has enumerated.
3. Select the .bin file using **Browse**… button
4. Click **Program SPI2 Flash**

FIGURE 6-19: SPI FLASH WRITER - SELECT DEVICE



5. After successful completion, the Status box will change to "Programming SPI2 flash completed successfully".

FIGURE 6-20: SPI FLASH WRITER - COMPLETED SUCCESSFULLY



6. Change the Bond2 jumper (J38) to 2-3 and reset the board. The EVB will now boot from SPI.

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